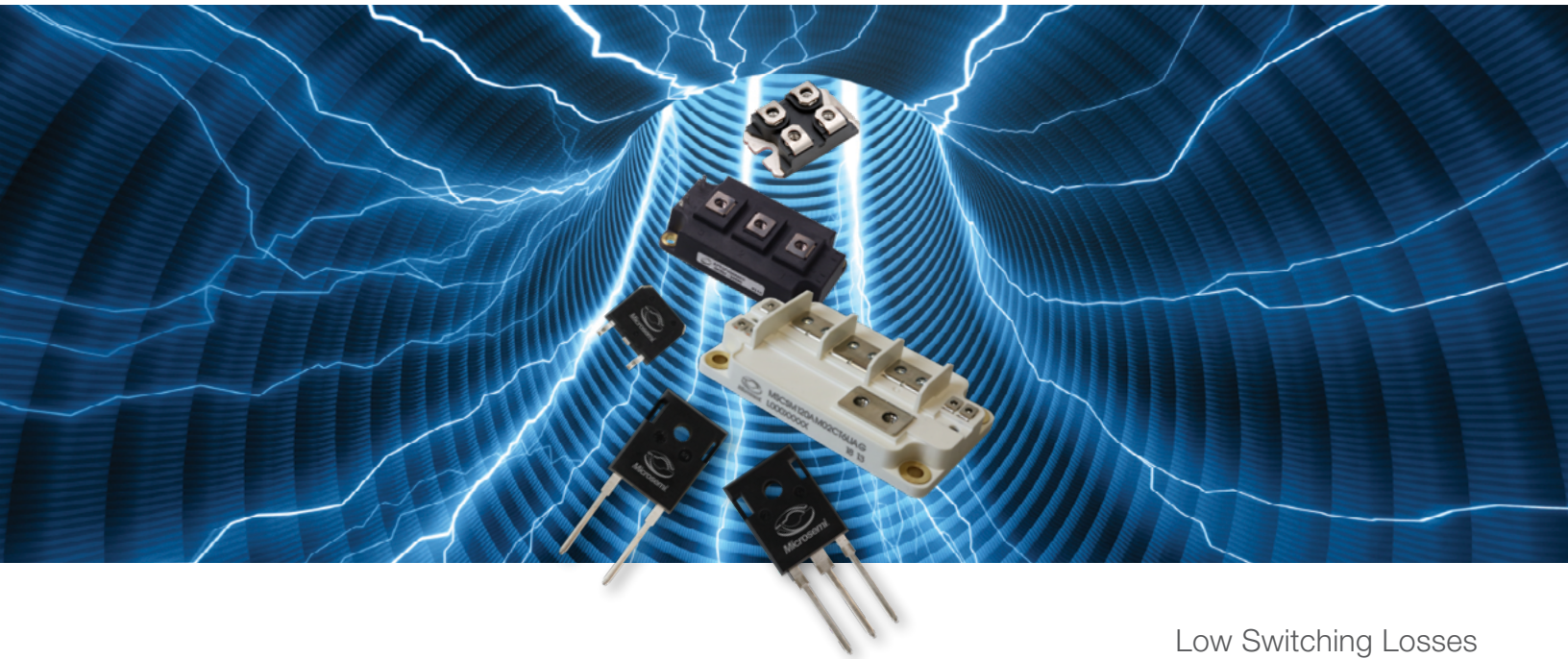


## Silicon Carbide Semiconductor Products



Low Switching Losses

Low Gate Resistance

High Power Density

High Thermal Conductivity

High Avalanche (UIS) Rating

Reduced Heat Sink Requirements

High Temperature Operation

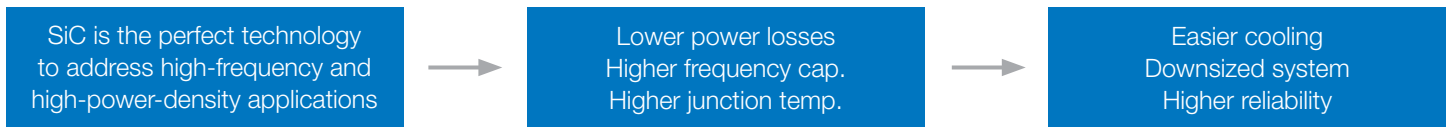
Reduced Circuit Size and System Costs

# Overview

## Breakthrough Technology Combines High Performance with Low Losses

- Extremely Low Switching Losses**
  - Zero reverse recovery charge improves system efficiency
- High Power Density**
  - Smaller footprint device reduces system size and weight
- High Thermal Conductivity**
  - 2.5x more thermally conductive than silicon
- Reduced Sink Requirements**
  - Results in lower cost and smaller size
- High Temperature Operation**
  - Increased power density and improved reliability

Silicon Carbide (SiC) semiconductors are an innovative new option for power electronic designers looking for improved system efficiency, smaller form factor and higher operating temperature in products covering industrial, medical, mil-aerospace, aviation, and communication market segments. Microsemi's next-generation SiC MOSFETs and SiC SBDs are designed with higher repetitive unclamped inductive switching (UIS) capability at rated current, with no degradation or failures. The new SiC MOSFETs maintain high UIS capability at approximately 10-15 Joules per square centimeter (J/cm<sup>2</sup>) and robust short circuit protection at 3-5 microseconds. The company's SiC SBDs are designed with balanced surge current, forward voltage, thermal resistance and thermal capacitance ratings at low reverse current for lower switching loss. In addition, its SiC MOSFET and SiC SBD die can be paired together for use in modules. SiC MOSFET and SiC SBD products from Microsemi will be qualified to the AEC-Q101 standard.



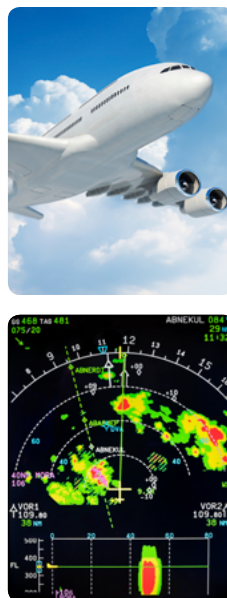
Automotive



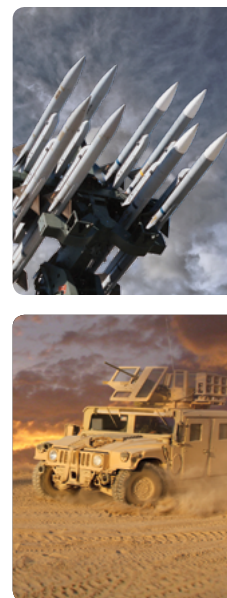
Industrial



Aviation



Defense



Medical



# Higher Switching Frequency

Silicon Carbide (SiC) is the ideal technology for higher switching frequency, higher efficiency, and higher power (>650 V) applications. Target markets and applications include:

- Industrial—motor drives, welding, UPS, SMPS, induction heating
- Transportation/automotive—EV battery charger, onboard chargers, hybrid electric vehicle (HEV)/electric vehicle (EV) powertrain, DC-DC converter, energy recovery
- Smart energy—PV inverter, wind turbine
- Medical—MRI power supply, X-ray power supply
- Commercial aviation—actuation, air conditioning, power distribution
- Defense—motor drives, auxiliary power supplies, integrated vehicle systems

SiC MOSFET and SiC Schottky Barrier Diode product lines from Microsemi increase your system efficiency over silicon MOSFET and IGBT solutions while lowering your total cost of ownership by enabling downsized systems and smaller/lower cost cooling.

## Full In-House and Foundry Capabilities

### Design

- Silvaco design and process simulator
- TCAD-TMA
- Mask-making and layout
- Solid works and FEA

### Process

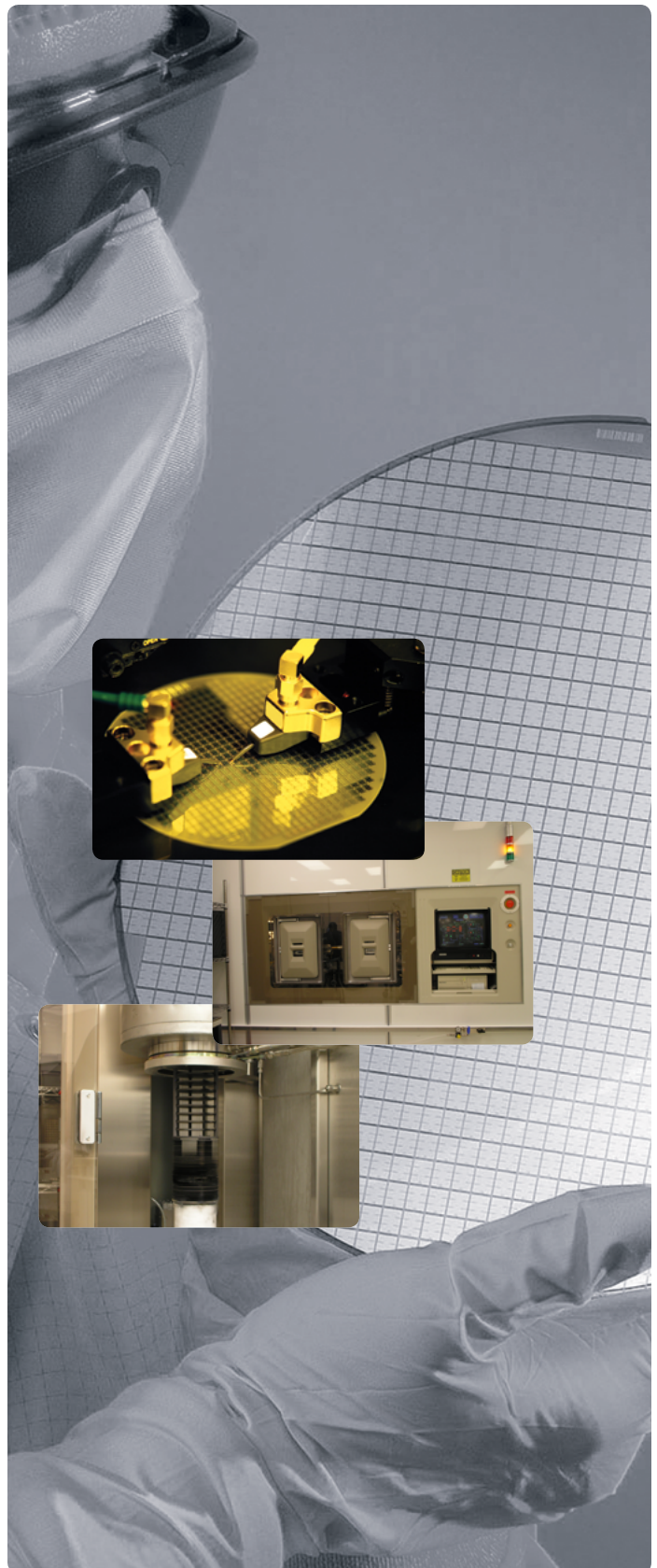
- High-temperature ion implantation
- High-temperature annealing
- SiC MOSFET gate oxide
- ASML steppers
- RIE and plasma etching
- Sputtered and evaporated metal deposition

### Analytical and Support

- SEM/EDAX
- Thermal imaging
- Photo Emission Microscope system (Phemos 1000)

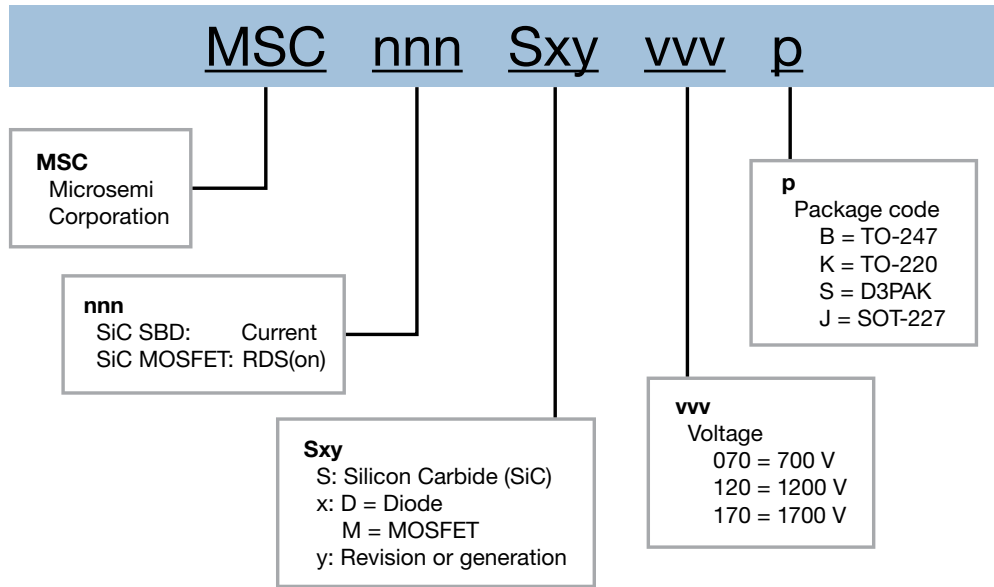
### Reliability Testing and Screening

- AEC-Q101
- HTRB and HTGB
- Sonoscan and X-ray

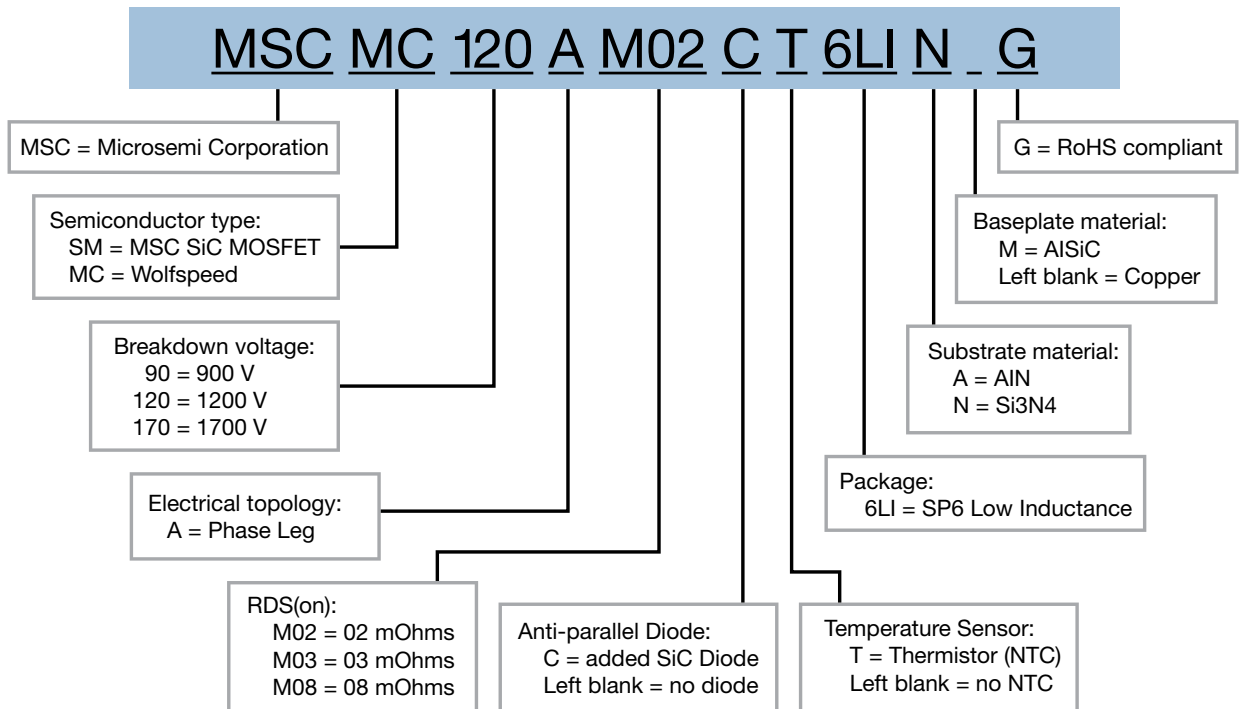


# SiC Discretes and Modules Nomenclature

## SiC Discretes



## SP6LI SiC Power Modules



# Discrete Products

## SiC Schottky Barrier Diodes

Part Number	Voltage (V)	I <sub>F</sub> (A)	Package
MSC010SDA070B	700	10	TO-247
MSC010SDA070K		10	TO-220
MSC030SDA070B		30	TO-247
MSC030SDA070K		30	TO-220
MSC050SDA070B		50	TO-247
MSC010SDA120B	1200	10	TO-247
MSC010SDA120K		10	TO-220
MSC015SDA120B		15	TO-247
MSC030SDA120B		30	TO-247
MSC030SDA120K		30	TO-220
MSC030SDA120S		30	D3PAK
MSC050SDA120B		50	TO-247
MSC050SDA120S	50	D3PAK	
MSC010SDA170B	1700	10	TO-247
MSC030SDA170B		30	TO-247
MSC050SDA170B		50	TO-247



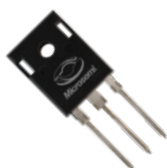
## SiC MOSFETs

Part Number	Voltage (V)	RDS(on)	Package
MSC090SMA070B	700	90 mΩ	TO-247
MSC090SMA070S			D3PAK
MSC060SMA070B		60 mΩ	TO-247
MSC060SMA070S			D3PAK
MSC035SMA070B			TO-247
MSC035SMA070S		35 mΩ	D3PAK
MSC015SMA070B		15 mΩ	TO-247
MSC015SMA070S	D3PAK		
MSC280SMA120B	1200	280 mΩ	TO-247
MSC280SMA120S			D3PAK
MSC140SMA120B		140 mΩ	TO-247
MSC140SMA120S			D3PAK
MSC080SMA120B			TO-247
MSC080SMA120S		80 mΩ	D3PAK
MSC080SMA120J		40 mΩ	SOT-227
MSC040SMA120B	TO-247		
MSC040SMA120S	D3PAK		
MSC040SMA120J	SOT-227		
MSC025SMA120B	25 mΩ	TO-247	
MSC025SMA120S		D3PAK	
MSC025SMA120J		SOT-227	
MSC750SMA170B	1700	750 mΩ	TO-247
MSC750SMA170S			D3PAK
MSC045SMA170B		45 mΩ	TO-247
MSC045SMA170S	D3PAK		

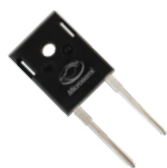


## SiC MOSFET Features and Benefits

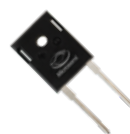
Characteristics	SiC vs. Si	Results	Benefits
Breakdown field (MV/cm)	10x higher	Lower on-resistance	Higher efficiency
Electron sat. velocity (cm/s)	2x higher	Faster switching	Size reduction
Bandgap energy (ev)	3x higher	Higher junction temperature	Improved cooling
Thermal conductivity (W/m.K)	3x higher	Higher power density	Higher current capabilities



TO-247-3L



TO-247



TO-220



D3PAK  
(TO-268)



SOT-227

# Power Modules

## Power Module Advantages

- High-speed switching
- Low switching losses
- Low input capacitance
- High power density
- Low profile packages
- Minimum parasitic inductance
- Lower system cost
- Standard & custom modules
- Choice of Si/SiC devices

## Standard Modules

Part Number	Type	Electrical Topology	Voltage (V)	Current	Package		
APT2X20DC60J	SiC Diode module	Dual diode	600	20	SOT227		
APT2X30DC60J				30	SOT227		
APT2X50DC60J				50	SOT227		
APT2X60DC60J				60	SOT227		
APT2X20DC120J			1200	20	SOT227		
APT2X40DC120J				40	SOT227		
APT2X50DC120J				50	SOT227		
APT2X60DC120J				60	SOT227		
APT40DC60HJ		Full bridge	600	40	SOT227		
APTDC40H601G				40	SP1		
APT10DC120HJ				1200	10	SOT227	
APT20DC120HJ					20	SOT227	
APTDC20H1201G			20		SP1		
APT40DC120HJ			40		SOT227		
APTDC40H1201G			40	SP1			
APT50MC120JCU2			SiC MOSFET module	Boost chopper	1200	50	SOT227
APT100MC120JCU2	100	SOT227					
APTMC120HM17CT3AG	Full bridge	110		SP3F			
APTMC120AM55CT1AG		40		SP1			
APTMC120AM25CT3AG	Phase leg	1200		80	SP3F		
APTMC120AM20CT1AG				100	SP1		
APTMC120AM16CD3AG				100	D3		
APTMC120AM12CT3AG				150	SP3F		
APTMC120AM08CD3AG				185	D3		
APTMC120AM09CT3AG				200	SP3F		
APTMC170AM60CT1AG				1700	40	SP1	
APTMC170AM30CT1AG					80	SP1	
APTMC60TL11CT3AG				Three level inverter	600	20	SP3F
APTMC60TLM55CT3AG						40	SP3F
APTMC60TLM14CAG	160	SP6					
APTMC120HR11CT3AG	Three phase bridge Triple phase leg	1200		20	SP3F		
APTMC120HRM40CT3AG				50	SP3F		
APTMC120TAM34CT3AG				55	SP3F		
APTMC120TAM33CTPAG				60	SP6P		
APTMC120TAM17CTPAG				100	SP6P		
APTMC120TAM12CTPAG				150	SP6P		
MSCMC120AM07CT6LIAG	Very Low Inductance SiC MOSFET module	Phase leg		1200	210	SP6LI	
MSCMC120AM04CT6LIAG					307	SP6LI	
MSCMC120AM03CT6LIAG					475	SP6LI	
MSCMC120AM02CT6LIAG					586	SP6LI	
MSCMC170AM08CT6LIAG					1700	207	SP6LI

## Customization

Microsemi offers a complete engineering solution with mix and match capabilities in terms of package, interconnection, configuration, performance, and cost.

Out of the existing standard power modules product line, Microsemi can offer simple, modified, or fully customized parts to meet 100% of our customers' needs.

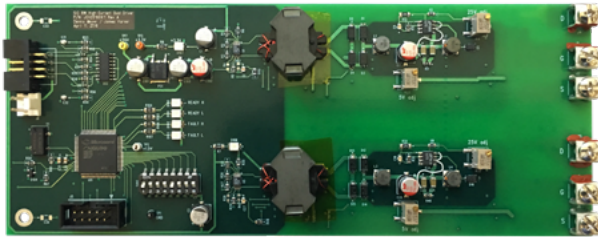
- Design expertise
- High power density
- Low profile packages
- Extended temperature capabilities
- Pin locating flexibility
- Mix of silicon

# Gate Driver Solutions

Microsemi and our partner ecosystem provide open-source, user friendly SiC MOSFET driver solutions that enable faster time to market for customers using our SiC MOSFETs and power modules. Customers can use isolated dual-gate driver referenced designs with our SiC MOSFETs in a number of SiC topologies.

## SiC MOSFET Driver Reference Designs With Isolation

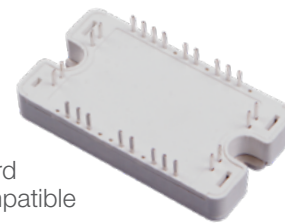
Part Number	Gate Drive Voltage (V)	Freq. (max)	Per Side Drive Power
MSCSICMDD/REF	-5/+20	400 kHz	8 W
MSCSICSP3/REF2	-5/+20	400 kHz	16 W



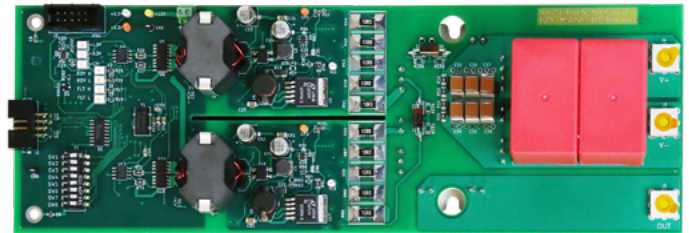
The MSCSICMDD/REF1 is a switch-configurable high/low-side driver with half bridges or independent drive

- 400kHz maximum switching frequency
- 8 W of gate drive power per side
- 30 A peak output current
- -5 V/+20 V gate drive voltage
- +/- 100 kV/uS capability
- Galvanic isolation of more than 2000 V on both gate drivers

[www.microsemi.com/product-directory/reference-designs/MSCSICMDD-REF1](http://www.microsemi.com/product-directory/reference-designs/MSCSICMDD-REF1)



SP3F standard package compatible



The MSCSICSP3/REF2 is a half bridge driver compatible with SP3F standard package modules

- 400kHz maximum switching frequency
- 16 W of gate drive power per side
- 30 A peak output current
- -5 V/+20 V gate drive voltage
- +/- 100 kV/uS capability
- Galvanic isolation of more than 2000 V on both gate drivers

[www.microsemi.com/product-directory/reference-designs/MSCSICSP3-REF2](http://www.microsemi.com/product-directory/reference-designs/MSCSICSP3-REF2)

Microsemi is continually adding new products to its industry-leading portfolio.

For the most recent updates to our product line and for detailed information and specifications, please call, email, or visit our website.

**Toll-free: 800-713-4113**

**[sales.support@microsemi.com](mailto:sales.support@microsemi.com)**

**[www.microsemi.com](http://www.microsemi.com)**



**Microsemi Corporate Headquarters**  
One Enterprise, Aliso Viejo, CA 92656 USA  
Within the USA: +1 (800) 713-4113  
Outside the USA: +1 (949) 380-6100  
Fax: +1 (949) 215-4996  
Email: [sales.support@microsemi.com](mailto:sales.support@microsemi.com)  
[www.microsemi.com](http://www.microsemi.com)

©2017–2018 Microsemi Corporation. All rights reserved. Microsemi and the Microsemi logo are registered trademarks of Microsemi Corporation. All other trademarks and service marks are the property of their respective owners.

Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions, security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, California and has approximately 4,800 employees globally. Learn more at [www.microsemi.com](http://www.microsemi.com).

Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction with mission-critical equipment or applications. Any performance specifications are believed to be reliable but are not verified, and Buyer must conduct and complete all performance and other testing of the products, alone and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi hereunder is provided "as is, where is" and with all faults, and the entire risk associated with such information is entirely with the Buyer. Microsemi does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other IP rights, whether with regard to such information itself or anything described by such information. Information provided in this document is proprietary to Microsemi, and Microsemi reserves the right to make any changes to the information in this document or to any products and services at any time without notice.



# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## Microsemi:

[MSC020SDA120B](#) [MSC025SMA120B](#) [MSC010SDA120B](#) [MSC060SMA070S](#) [MSC140SMA120B](#)  
[MSC090SMA070B](#) [MSC015SMA070B](#) [MSC030SDA120S](#) [MSC030SDA120K](#) [MSC025SMA120S](#) [MSC090SMA070S](#)  
[MSC050SDA070B](#) [MSC050SDA120B](#) [MSC010SDA070K](#) [MSC080SMA120J](#) [MSC010SDA170B](#) [MSC035SMA070S](#)  
[MSC040SMA120B](#) [MSC280SMA120B](#) [MSC015SMA070S](#) [MSC060SMA070B](#) [MSC050SDA120S](#)  
[MSC040SMA120S](#) [MSC030SDA070B](#) [MSC080SMA120S](#) [MSC080SMA120B](#) [MSC030SDA070K](#) [MSC280SMA120S](#)  
[MSC025SMA120J](#) [MSC010SDA070B](#) [MSC035SMA070B](#) [MSC015SDA120B](#) [MSC040SMA120J](#) [MSC140SMA120S](#)  
[MSCSICMDD/REF1](#)